TOSHIBA PHOTOCOUPLER PHOTO RELAY

TLP3212

Battery Control Measuring Instruments Logic IC Testers / Memory Testers

The TOSHIBA TLP3212 is an ultra-small photorelay suitable for surface-mount assembly. The TLP3212 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOSFET and is housed in a 4-pin package.

Its features include low Off-state current and low output pin capacitance.

Features

- 4-pin SSOP (SSOP4): 1.8 mm high, 1.27 mm pitch
- 1-Form-A

1 **[**

2 **C**

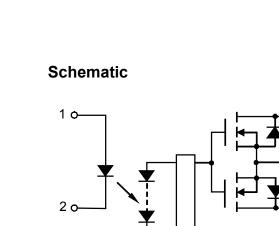
- Peak Off-State Voltage: 60 V (min)
- Trigger LED Current: 5 mA (max)
- On-State Current: 400 mA (max)
- On-State Resistance: $1.5\Omega(max)$, 1.0Ω (typ.)

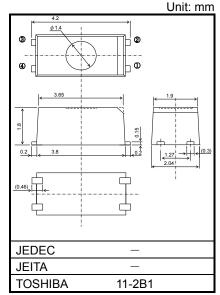
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- Isolation Voltage: 1500 Vrms (min)
- UL approved: UL1577, File No.E67349







Weight: 0.03 g (typ.)

1 : ANODE 2 : CATHODE 3 : DRAIN 4 : DRAIN o 4

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Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	lF	50	mA
	Forward Current Derating (Ta $\ge 25^{\circ}$ C)	∆IF/°C	-0.5	mA/°C
Q	Reverse Voltage	VR	5	V
LED	Diode Power Dissipation	PD	50	mW
	Diode Power Dissipation Derating (Ta ≥ 25°C)	∆P _D /°C	-0.5	mW/°C
	Junction Temperature	Tj	125	°C
	Off-State Output Terminal Voltage	VOFF	60	V
DETECTOR	On-State Current	I _{ON}	400	mA
	On-State Current Derating (Ta \ge 25°C)	∆lon/°C	-4.0	mA/°C
ETE	Output Power Dissipation	Po	240	mW
	Output Power Dissipation Derating (Ta \ge 25°C)	ΔP _o /°C	-2.4	mW / °C
	Junction Temperature	Tj	125	°C
Stora	ge Temperature Range	T _{stg}	-40 to 125	°C
Oper	ating Temperature Range	Topr	-20 to 85	°C
Lead	Soldering Temperature (10 s)	T _{sol}	260	°C
Isolat	tion Voltage (AC, 60 s, R.H. \leq 60%) (Note 1)	BVS	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	VDD	_	_	48	V
Forward Current	lF	-	_	20	mA
On-State Current	ION	-	_	400	mA
Operating Temperature	Topr	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the devices. Each item also has its own independent guideline document. In developing designs using these products, please confirm the specified characteristics shown in these documents.

Note1: Device considered a two-terminal device. Pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

Individual Electrical Characteristics (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Forward Voltage	VF	IF = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	IR	V _R = 5 V	_	-	10	μA
	Capacitance	CT	V = 0 V, f = 1 MHz	_	15	_	pF
ECTOR	Off-State Current	IOFF	VOFF = 60 V	_	-	1	μΑ
DETE	Capacitance	COFF	V = 0 V, f = 1 MHz, t < 1 s	_	20	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Trigger LED Current	I _{FT}	I _{ON} = 100 mA,	_	2	5	mA
Close LED Current	IFC	IOFF = 10 μA	0.2	—	—	mA
On-State Resistance	Ron	I _{ON} = 400 mA, I _F = 5 mA		1.0	1.5	Ω

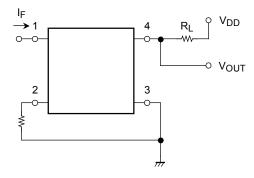
Isolation Characteristics (Ta = 25°C)

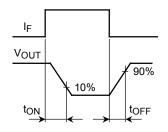
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance Input to Output	CS	$V_S = 0 V$, f = 1 MHz	_	0.3	_	pF
Isolation Resistance	Rs	$V_S=500~V,~R.H.\leq 60\%$	$5 imes 10^{10}$	10 ¹⁴	_	Ω
		AC, 60 s	1500	_	_	Vrms
Isolation Voltage	BVS	AC, 1 s (in oil)	—	3000	_	vinis
		DC, 60 s (in oil)	—	3000	_	Vdc

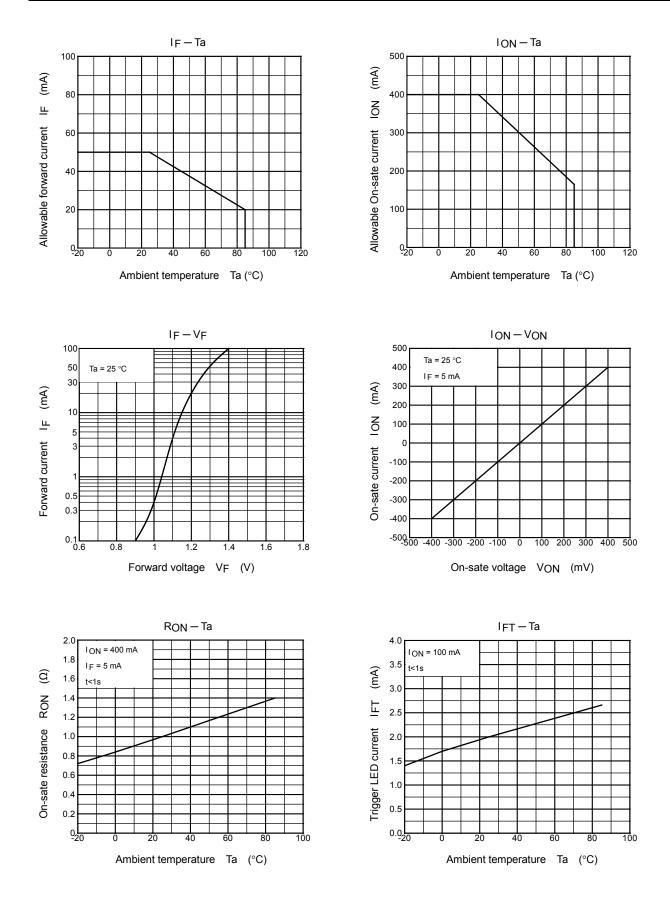
Switching Characteristics (Ta = 25°C)

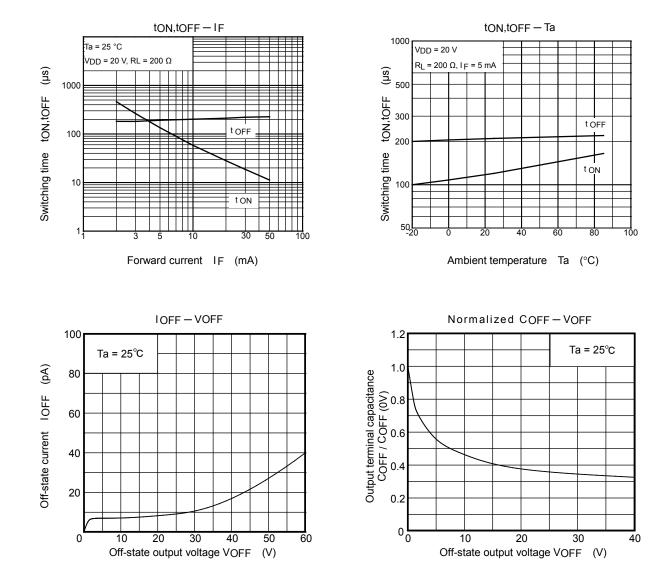
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Turn-on Time	ton	$R_L = 200 \Omega$ (Note 2)	_	300	1000	
Turn-off Time	tOFF	V _{DD} =20 V, I _F = 5 mA		200	1000	μS

Note 2: Switching time test circuit

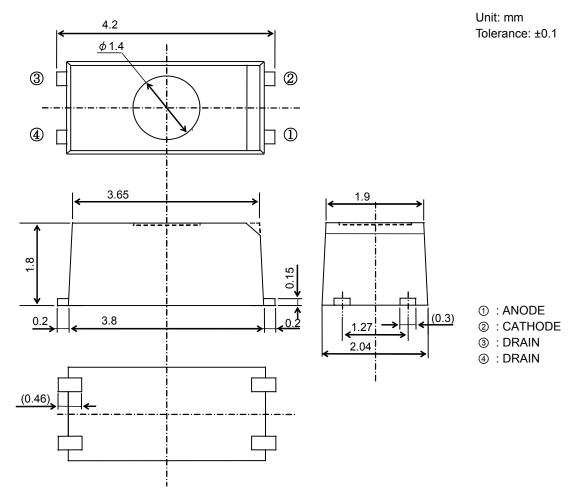








Package Dimensions



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